ShiLing® 浙江世菱半导体有限公司
ZHEJIANG SHILING SEMICONDUCTOR CO.,LTD.

产品规格书

Specifcation of products

产品名称:可控硅模块

产品型号:MTG150A-T21

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ZHEJIANG SHILING SEMICONDUCTOR CO.,LTD.

地址:浙江省 丽水市 莲都区
电话:(0578)3012571 3615078
传真:(0578)3611180
邮编: 323000
E-mail:smrshiling01@163.com
Http//www.smrshiling.com

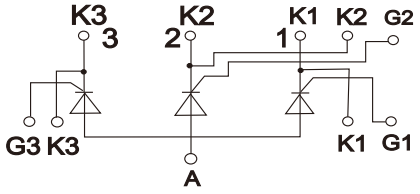
拟制	审核	核准
林益龙	曹剑龙	宗瑞

版本号:05 更新日期:2023.8

SYMBOL	CHARACTERISTIC	TEST CONDITIONS	T_j(°C)	VALUE			UNIT
				Min	Type	Max	
$I_{T(AV)}$	Mean on-state current	180° half sine wave 50Hz Single side cooled,T_C=90°C	125			150	A
$I_{T(RMS)}$	RMS on-state current	Single side cooled,T_C=90°C	125			236	A
V_{DRM} V_{RRM}	Repetitive peak off-state voltage Repetitive peak reverse voltage	V_{DRM}&V_{RRM} tp=10ms V_{DsM}&V_{RsM}= V_{DRM}&V_{RRM}+200V respectively	125	800		1800	V
I_{DRM} I_{RRM}	Repetitive peak current	at V_{DRM} at V_{RRM}	125			12	mA
I_{TSM}	Surge on-state current	10ms half sine wave V_R=60%V_{RRM}	125			5.10	KA
I^2t	I^2T for fusing coordination					133	A^2s*10^3
V_{TO}	Threshold voltage		125			0.80	V
r_T	On-state slop resistance					1.74	mΩ
V_{TM}	Peak on-state voltage	I_{TM}=450A	125			1. 4	V
dv/dt	Critical rate of rise of off-state voltage	V_{DM}=67%V_{DRM}	125			800	V/μs
di/dt	Critical rate of rise of on-state current	From 67%V_{DRM} to 450A, Gate source 1.5A t_r ≤0.5μs Repetitive	125			100	A/μs
I_{GT}	Gate trigger current	V_A=12V, I_A=1A	25	30		150	mA
V_{GT}	Gate trigger voltage			0.8		2.0	V
I_H	Holding current			20		100	mA
V_{GD}	Non-trigger gate voltage	At 67%V_{DRM}	125			0.2	V
$R_{th(j-c)}$	Thermal resistance Junction to heatsink	Single side cooled				0.160	°C /W
F_m	Thermal connection torque(M8)				7.0		N.m
	Mounting torque(M6)				5.0		N.m
T_{stg}	Stored temperature			-40		140	°C
W_t	Weight				207		g
Outline							

OUTLINE DRAWING & CIRCUIT DIAGRAM

MTG



Rating and Characteristic

Peak forward Voltage Vs.Peak on-state Current

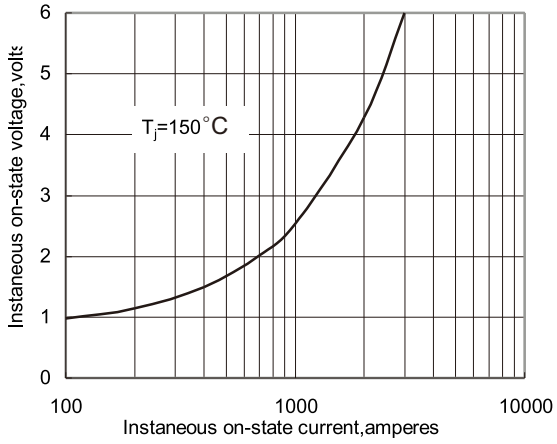


Fig.1

Max. junction To case Thermai Impedance Vs.Time

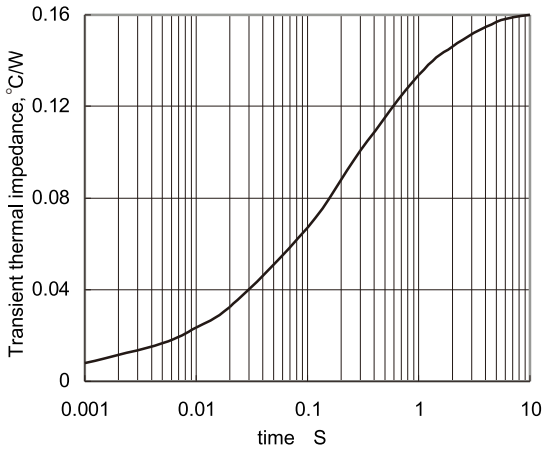


Fig.2

Max. Power Dissipation Vs.on-state Current

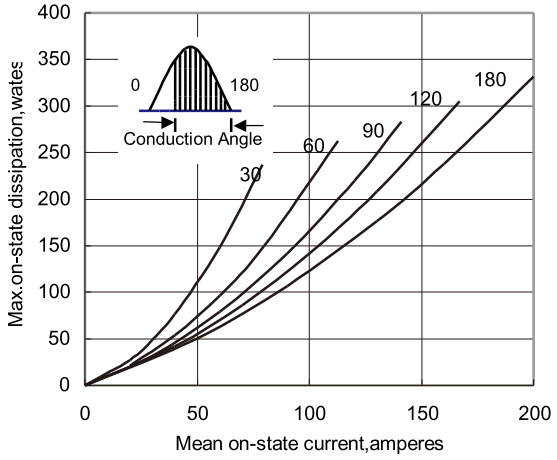


Fig.3

Max. case Temperature Vs.Mean on-state Current

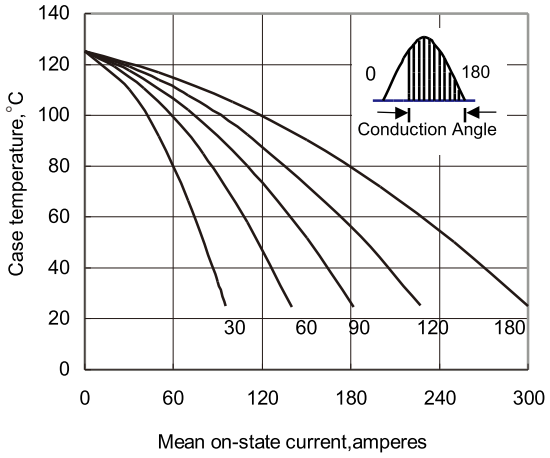


Fig.4

Max. Power Dissipation Vs.Mean on-state Current

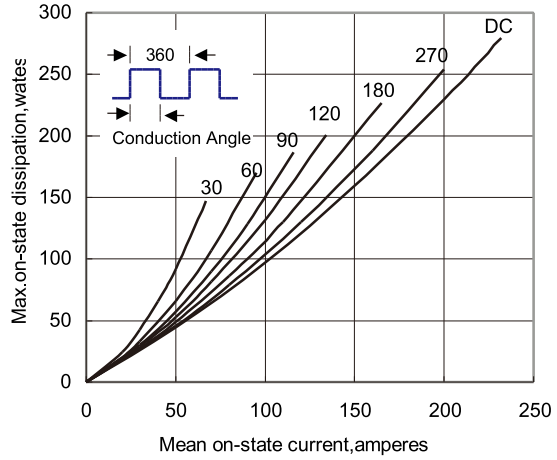


Fig.5

Max. case Temperature Vs.Mean on-state Current

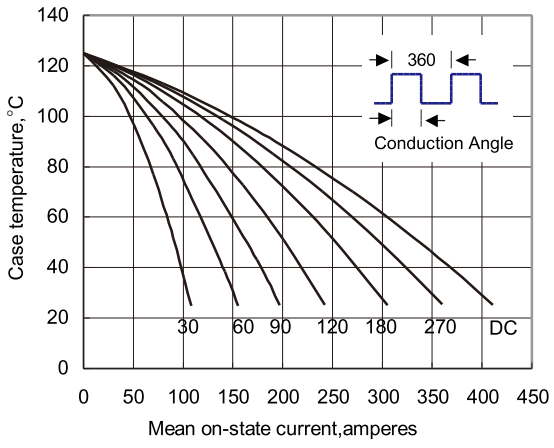


Fig.6

Outside Dimension